

#### 100V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
100V	$350m\Omega$ @ $V_{GS} = 10V$	2.4A
	$450m\Omega$ @ $V_{GS} = 6.0V$	2.1A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- DC-DC Converters
- Power Management Functions
- Uninterrupted Power Supply

#### **Features and Benefits**

- · Fast Switching Speed
- Low Gate Drive
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

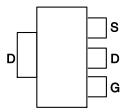
#### **Mechanical Data**

- Case: SOT223
- Case Material: Molded Plastic; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe;
   Solderable per MIL-STD-202, Method 208
- Weight: 0.112 grams (Approximate)

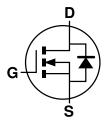




Top View



Pin Out - Top View



Equivalent Circuit

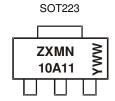
### **Ordering Information** (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN10A11GTA	See Below	7	12	1,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



ZXMN10A11 = Product Type Marking Code YWW = Date Code Marking Y or  $\overline{Y}$  = Last Digit of Year (ex: 5= 2015) WW or  $\overline{W}$ W = Week Code (01~53)



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage	Drain-Source Voltage			100	V
Gate-Source Voltage	Gate-Source Voltage			±20	V
		(Note 6)		2.4	
Continuous Drain Current V	$V_{GS} = 10V$	$T_A = +70^{\circ}C \text{ (Note 6)}$	$I_{D}$	1.9	Α
		(Note 5)		1.7	
Pulsed Drain Current	V <sub>GS</sub> = 10V	(Note 7)	I <sub>DM</sub>	7.9	Α
Continuous Source Current (Body Diode) (Note 6)		(Note 6)	Is	4.6	Α
Pulsed Source Current (Body Diode) (Note 7)		I <sub>SM</sub>	7.9	Α	

## Thermal Characteristics (@TA = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 5)	,	2.0 16	W mW/°C	
Linear Derating Factor	(Note 6)	P <sub>D</sub>	3.9 31		
Thermal Resistance, Junction to Ambient	(Note 5)	Б	62.5	°C/W	
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	32.0	G/VV	
Thermal Resistance, Junction to Lead	(Note 8)	$R_{ hetaJL}$	9.8	°C/W	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C	

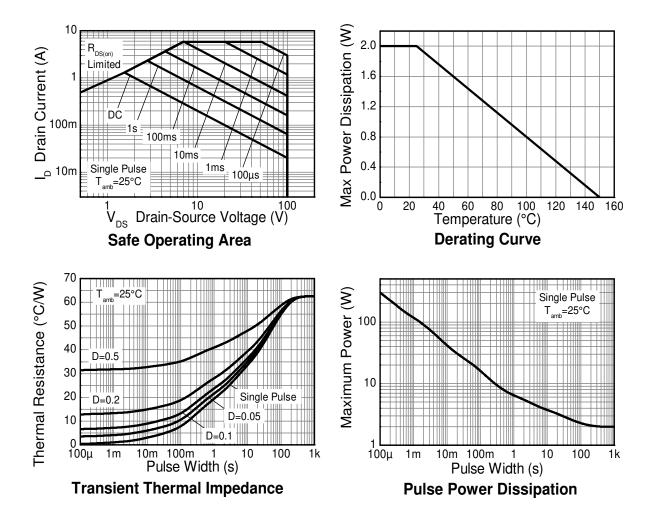
Notes:

- 5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is a. For a device surface modified on 25mm x 25mm x 1.5mm PA4 PCB with high coverage of single sided 102 copper, in still all conditions, the device is measured when operating in a steady-state condition.
  b. Same as Note 5, except the device is measured at t ≤ 10 seconds.
  c. Same as Note 5, except the device is pulsed with D = 0.02 and pulse width 300μs. The pulse current is limited by the maximum junction temperature.

- 8. Thermal resistance from junction to solder-point (at the end of the drain lead).



## **Thermal Characteristics**





## Electrical Characteristics (@T<sub>A</sub> = +25°C unless otherwise specified.)

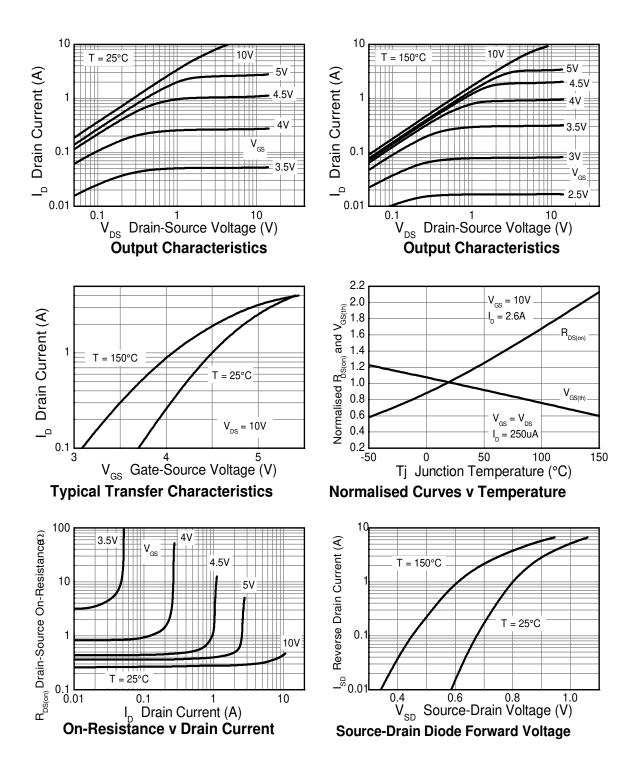
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 100V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS			•		•		
Gate Threshold Voltage	$V_{GS(th)}$	2.0	_	4.0	V	$I_D = 250\mu A, V_{DS} = V_{GS}$	
Static Drain-Source On-Resistance (Note 9)	Б			0.35	Ω	$V_{GS} = 10V, I_D = 2.6A$	
Static Drain-Source Off-Resistance (Note 9)	R <sub>DS (ON)</sub>	_	_	0.45	12	V <sub>GS</sub> = 6V, I <sub>D</sub> = 1.3A	
Forward Transconductance (Notes 9 & 10)	<b>g</b> fs	_	4	_	S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 2.6A	
Diode Forward Voltage (Note 9)	$V_{SD}$	_	0.85	0.95	V	I <sub>S</sub> = 1.85A, V <sub>GS</sub> = 0V	
Reverse Recovery Time (Note 10)	t <sub>rr</sub>		26	_	ns	I <sub>F</sub> = 1.0A, di/dt = 100A/μs	
Reverse Recovery Charge (Note 10)	Q <sub>rr</sub>		30	_	nC		
DYNAMIC CHARACTERISTICS (Note 6)			•		•		
Input Capacitance	Ciss	_	274	_	pF	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V -f = 1MHz	
Output Capacitance	Coss	_	21	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	11	_	pF	1 - 11/11/12	
Total Gate Charge (Note 11)	$Q_g$	_	3.5	_	nC	V <sub>GS</sub> = 6.0V	
Total Gate Charge (Note 11)	$Q_g$	_	5.4	_	nC	$V_{DS} = 50V$	
Gate-Source Charge (Note 11)	Qgs	_	1.4	_	nC	V <sub>GS</sub> = 10V I <sub>D</sub> = 2.5A	
Gate-Drain Charge (Note 11)	$Q_{gd}$	_	1.5	_	nC	]	
Turn-On Delay Time (Note 11)	t <sub>D(on)</sub>	_	2.7		ns	$V_{DD} = 50V, V_{GS} = 10V$ $I_D = 1A, R_G \cong 6.0\Omega$	
Turn-On Rise Time (Note 11)	t <sub>r</sub>	_	1.7	_	ns		
Turn-Off Delay Time (Note 11)	t <sub>D(off)</sub>	_	7.4		ns		
Turn-Off Fall Time (Note 11)	t <sub>f</sub>		3.5		ns		

Notes:

<sup>9.</sup> Measured under pulsed conditions. Pulse width  $\leq 300\mu s$ ; duty cycle  $\leq 2\%$ . 10. For design aid only, not subject to production testing. 11. Switching characteristics are independent of operating junction temperatures.

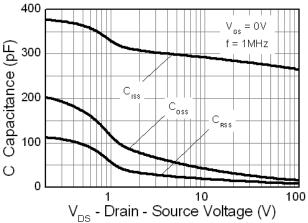


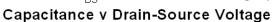
## **Typical Characteristics**

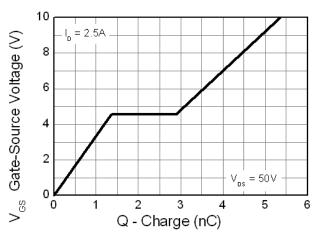




## **Typical Characteristics** (cont.)

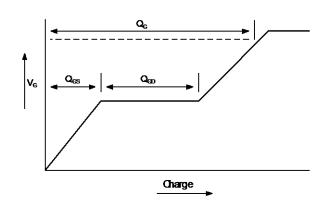




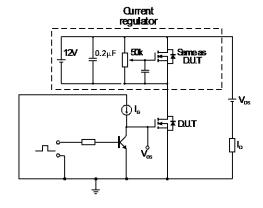


Gate-Source Voltage v Gate Charge

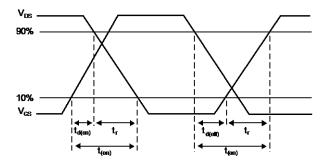
### **Test Circuits**



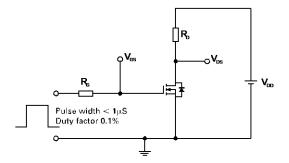
Basic gate charge waveform



Gate charge test circuit



Switching time waveforms

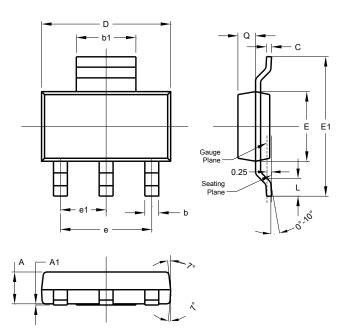


Switching time test circuit



# **Package Outline Dimensions**

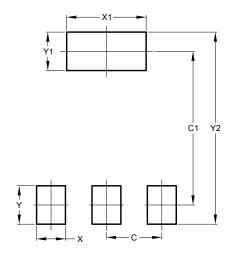
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
<b>A</b> 1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Υ	1.60
Y1	1.60
Y2	8.00



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